

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|---|---|------------------|---------|------------------|
| S1 | 19 | choi-jong-soo.in. or ((jong adj soo) near2 choi) or (jong-soo near2 choi) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/01/31 17:38 |
| S2 | 13 | kim-byung-man.in. or ((byung adj man) near2 kim) or (byung-man near2 kim) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/01/31 17:38 |
| S3 | 11 | S2 not S1 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/01/31 17:40 |
| S4 | 5 | lee-joung-rhang.in. or ((joung adj rhang) near2 lee) or (joung-rhang near2 lee) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/01/31 17:41 |
| S5 | 4 | S4 not (S1 or S3) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/01/31 17:41 |
| S6 | 5 | park-chang-yong.in. or ((chang adj yong) near2 park) or (chang-yong near2 park) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/01/31 17:42 |
| S7 | 3 | S6 not (S1 or S3 or S5) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/01/31 17:43 |
| S8 | 1 | ("5644839").PN. | US-PGPUB; USPAT | OR | OFF | 2006/01/31 18:30 |
| S9 | 471 | 228/248.1.ccls. | US-PGPUB; USPAT; DERWENT | OR | ON | 2006/01/31 18:46 |
| S10 | 115 | 228/248.1.ccls. | EPO; JPO | OR | ON | 2006/01/31 18:46 |
| S11 | 451 | 228/223.ccls. | US-PGPUB; USPAT; DERWENT | OR | ON | 2006/01/31 18:46 |
| S12 | 25 | 228/223.ccls. | EPO; JPO | OR | ON | 2006/01/31 18:46 |
| S13 | 54 | solder\$3 with card with slot and pin | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 10:19 |
| S14 | 8757 | solder\$3 with (screen or stencil) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 10:30 |

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| S15 | 3380 | S14 and reflow\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 10:30 |
| S16 | 1482 | S15 and flux | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 10:30 |
| S17 | 1443 | S16 and (PCB or IC or circuit or semiconductor or (printed adj circuit) or (integrated circuit) or card) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 10:32 |
| S18 | 122 | S17 and slot | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 10:35 |
| S19 | 65 | S18 and pin | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 10:35 |
| S20 | 86 | ("3320658" "3719981" "3864004" "3889364" "4056302" "4097266" "4380518" "4396140" "4462534" "4641426" "4664309" "4678250" "4705205" "4722470" "4767344" "4830264" "4871110" "4884335" "5024372" "5060844" "5093986" "5111991" "5118027" "5131871" "5145104" "5203075" "5207372" "5222649" "5229016" "5255839" "5261155" "5269453" "5275330" "5284287" "5324569" "5346118" "5355283" "5358417" "5377902" "5387139" "5409157" "5410807" "5431332" "5435482" "5442852" "5445313" "5467913" "5477933" "5489750" "5491303" "5492266" "5495668" "5499487" "5504277" "5516030" "5516032" "5518410" "5519580" "5534127" "5539153" "5542174" "5591941" "5593322" "5702255" "5730606" "5746608" "5772451").PN. OR ("6079991").URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2006/02/01 12:06 |
| S21 | 2417 | tab same PCB | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 15:12 |

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| S22 | 115 | S21 and (pin adj connector) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 15:12 |
| S23 | 54 | S22 and solder\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 15:19 |
| S24 | 88 | PCB same (pin adj connector) same solder\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 15:23 |
| S25 | 1973 | ((card or PCB or board or circuit) with slot) same solder\$3) and (pin or connector or (pin near2 connector)) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 15:25 |
| S26 | 191 | S25 and reflow | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 15:25 |
| S27 | 219 | S25 and reflow\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 15:26 |
| S28 | 39 | S27 and flux | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:33 |
| S29 | 2270 | (solder\$3 with reflow) and (flux with reflow) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:41 |
| S30 | 540 | S29 and "228".clas. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:34 |
| S31 | 101 | S30 and PCB | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:35 |
| S32 | 2060 | (solder\$3 with reflow) with (flux with reflow) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:41 |
| S33 | 6 | S31 not S32 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:45 |

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| S34 | 390 | flux adj5 (over or cover\$3 or protect\$3) adj5 solder\$3 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:46 |
| S35 | 334 | S34 and (pcb or circuit or pad or land or ic or chip) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:46 |
| S36 | 103 | S35 and "228".clas. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:47 |
| S37 | 162 | S34 and reflow | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:47 |
| S38 | 68 | S37 and "228".clas. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:53 |
| S39 | 244 | flux adj5 after adj5 solder | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:53 |
| S40 | 58 | S39 and "228".clas. | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2006/02/01 16:53 |